

# eMD-SmartMotion\_ICM20948 Software Release Notes



# **CONTENTS**

Overview	3
Supported Sensors	3
Software Modules Included	
Supported Features	
New Features	
Known Issues	
Test Platform	
Notes	
Compliance Declaration Disclaimer	5



#### **OVERVIEW**

This document details the relevant information regarding the eMD-SmartMotion\_ICM20948-1.1.0 software release.

# SUPPORTED SENSORS

- ICM20948

# SOFTWARE MODULES INCLUDED

The eMD-SmartMotion package includes all the necessary files to create a custom application for any of the supported ICM sensors (see above).

The package is organized as follow

- **doc:** Document(s) describing the use of this firmware development platform.
- EMD-App: contains sample firmware source and project files.
  - o src:
- At the top level: Shared .c & .h files.
- ASF: Shared Atmel system files.
- config: Shared config files.
- ICM\*: Sensor specific files, main.[c,h], sensor.[c,h] and system.[c,h].
- \*.cproj: AtmelStudio project file for the supported sensor.
- **EMD-Core:** Contains TDK driver files. These files are built into an archive libEMD-Core-ICM\*.a. Each supported sensor has it's own .a file.
  - config: The Makefile(s) used to create the sensor driver archives.
  - o sources/Invn: TDK libraries source files.
  - o \*.cproj: AtmelStudio project files for each of the supported sensors.
- scripts Batch files for building and flashing release versions of the firmware for each sensor.
- tools The files required to run the host application sensor-cli.
- EMD-G55-ICM\*.atsin Atmel Studio solution files for each of the supported sensors.
- release Contains precompiled elf and binary files

# SUPPORTED FEATURES

Sensor features supported:

- Raw accelerometer
- Raw Gyroscope
- Calibrated accelerometer
- Calibrated gyroscope
- Uncalibrated gyroscope
- Game rotation vector
- Gravity
- Linear Acceleration

Optional sensor features supported:

- Calibrated magnetometer (AKM9916 only)
- Uncalibrated magnetometer
- Rotation vector
- Geomagnetic rotation vector
- Step Detector
- Step Counter
- Tilt Detector
- Pick-Up Gesture
- BAC (Activity Classifier)

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- B2S
- SMD

# **NEW FEATURES**

- Addition of Accel and gyro offset driver API
- Support for non-default mag mounting matrix

# KNOWN ISSUES

- SPI clock interface speed should not be set higher than 2.5MHz to ensure sensor data consistency
- SMD detection for running like motion has not been supported
- Occasional Time-stamp jitter observed during stress-test Occasionally, accelerometer data in wrong rate and/or no magnetometer data have been seen after many iteration of command sequences like, set odr, enable-disable continuous and non-continuous sensors. This unexpected system behavior has been seen during stress-test, only for SPI configuration on SmartMotion platform (Atmel G55 based). The state can be recovered by restarting the sensor-cli application (resets the device in software) or resetting the device manually. The issue has not been seen for SmartMotion I2C interface or other MCU platforms using SPI interface.

# TEST PLATFORM

This section describes the software test platform used during the test

Software Component		
Package	eMD-SmartMotion_ICM20948-1.1.0	
Host	Windows 7	
Hardware Component		
eMD Platform	SmartMotion board with onboard	
	ICM20048	

# **NOTES**

ICM20948:

This release provides standalone example applications that run on the eMDSmartMotion platform only. A host application, sensor-cli, that runs on a Windows PC and communicates with the eMD-SmartMotion firmware through a TDK transport protocol is included within this release.

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